

● General Description

The AGM628M combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$.

This device is ideal for load switch and battery protection applications.

● Features

- Advance high cell density Trench technology
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

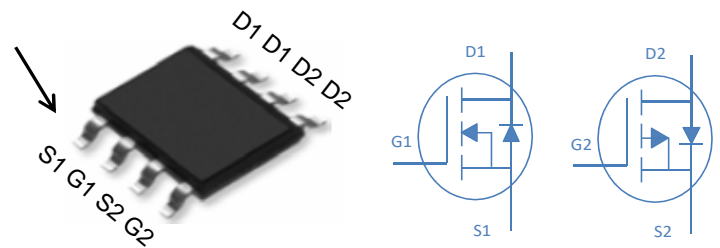
● Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDSON	ID
60V	27mΩ	6.8A
-60V	53mΩ	-5.7A

SOP8 Pin Configuration



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM628M	AGM628M	SOP8	--mm	--mm	3000

Table 1. Absolute Maximum Ratings (TA=25°C)

Symbol	Parameter	Rating		Units
		N-Ch	P-Ch	
V_{DS}	Drain-Source Voltage ($V_{GS}=0V$)	60	-60	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0V$)	±20	±20	V
I_D	Drain Current-Continuous($T_c=25^\circ C$) (Note 1)	6.8	-5.7	A
	Drain Current-Continuous($T_c=100^\circ C$)	3.2	-2.6	A
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 2)	9.6	-7.5	A
P_D	Total Power Dissipation($T_c=25^\circ C$)	3.5	3.5	W
	Total Power Dissipation($T_c=100^\circ C$)	1.4	1.4	W
EAS	Avalanche energy (Note 3)	22	18	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient (Steady State) ¹	---	85	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-Case ¹	---	36	°C/W

Table 3. N- Channel Electrical Characteristics (TA=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	60	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=60V, VGS=0V	--	--	1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V, VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS, ID=250μA	1.0	1.6	2.5	V
gFS	Forward Transconductance	VDS=5V, ID=6A	--	35	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=6A	--	27	40	mΩ
		VGS=4.5V, ID=5A	--	36	50	mΩ
Dynamic Characteristics						
Ciss	Input Capacitance	VDS=30V, VGS=0V, F=1MHZ	--	916	--	pF
Coss	Output Capacitance		--	42	--	pF
Crss	Reverse Transfer Capacitance		--	38	--	pF
Rg	Gate resistance	VGS=0V, VDS=0V, f=1.0MHz	--	--	--	Ω
Switching Times						
td(on)	Turn-on Delay Time	VGS=10V, VDS=30V, RL=2.5Ω, RGEN=3Ω	--	4.5	--	nS
tr	Turn-on Rise Time		--	18	--	nS
td(off)	Turn-Off Delay Time		--	14.5	--	nS
tf	Turn-Off Fall Time		--	18	--	nS
Qg	Total Gate Charge	VGS=10V, VDS=30V, ID=3A	--	19	--	nC
Qgs	Gate-Source Charge		--	4.2	--	nC
Qgd	Gate-Drain Charge		--	2.5	--	nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)		--	--	6.8	A
VSD	Forward on Voltage	VGS=0V, IS=2A	--	0.8	1.2	V
trr	Reverse Recovery Time	IF=2A , dI/dt=100A/μs , TJ=25°C	--	--	--	ns
Qrr	Reverse Recovery Charge		--	--	--	nc

Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25°C

Table 3. P-Channel Electrical Characteristics (TA=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=-250μA	-60	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=-60V,VGS=0V	--	--	-1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=-250μA	-1.1	-1.7	-2.5	V
gFS	Forward Transconductance	VDS=-10V,ID=-2A	--	32	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=-10V, ID=-6A	--	53	67	mΩ
		VGS=-4.5V, ID=-5A	--	67	88	mΩ
Dynamic Characteristics						
Ciss	Input Capacitance	VDS=-30V,VGS=0V, F=1MHZ	--	1200	--	pF
Coss	Output Capacitance		--	75	--	pF
Crss	Reverse Transfer Capacitance		--	58	--	pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz	--	7	--	Ω
Switching Times						
td(on)	Turn-on Delay Time	VGS=-10V,VDS=-30V, RGEN=3Ω	--	--	--	nS
tr	Turn-on Rise Time		--	--	--	nS
td(off)	Turn-Off Delay Time		--	--	--	nS
tf	Turn-Off Fall Time		--	--	--	nS
Qg	Total Gate Charge	VGS=-10V, VDS=-30V, ID=-3A	--	25	--	nC
Qgs	Gate-Source Charge		--	5.8	--	nC
Qgd	Gate-Drain Charge		--	3.1	--	nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)		--	--	-5.7	A
VSD	Forward on Voltage	VGS=0V,IS=-2A	--	-0.8	-1.2	V
trr	Reverse Recovery Time	IF=-2A , dl/dt=100A/μs , TJ=25°C	--	--	--	ns
Qrr	Reverse Recovery Charge		--	--	--	nc

Notes 1.The maximum current rating is package limited.

Notes2.Repetitive Rating: Pulse width limited by maximum junction temperature Notes

3.EAS condition: TJ=25°C

N-Channel Typical Characteristics

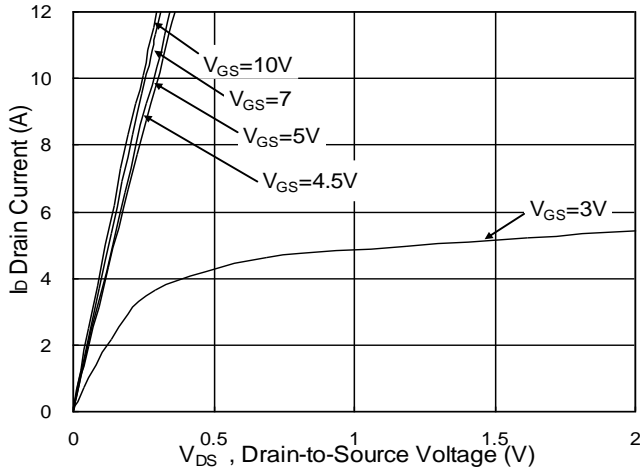


Fig.1 Typical Output Characteristics

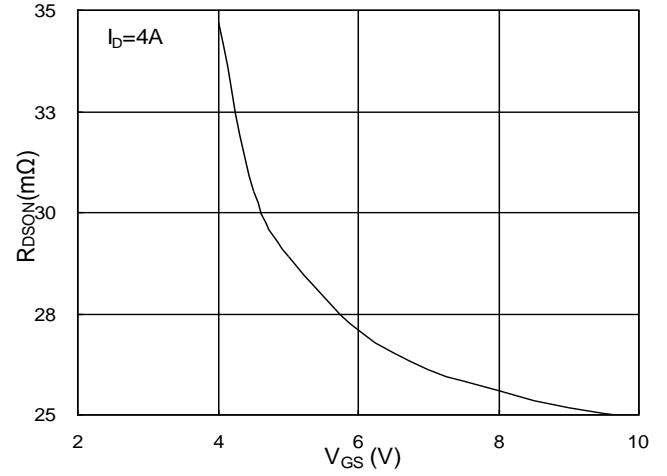


Fig.2 On-Resistance v.s Gate-Source

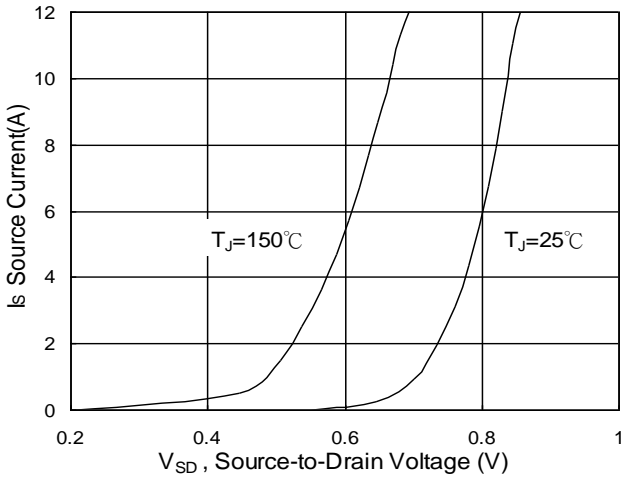


Fig.3 Forward Characteristics of Reverse

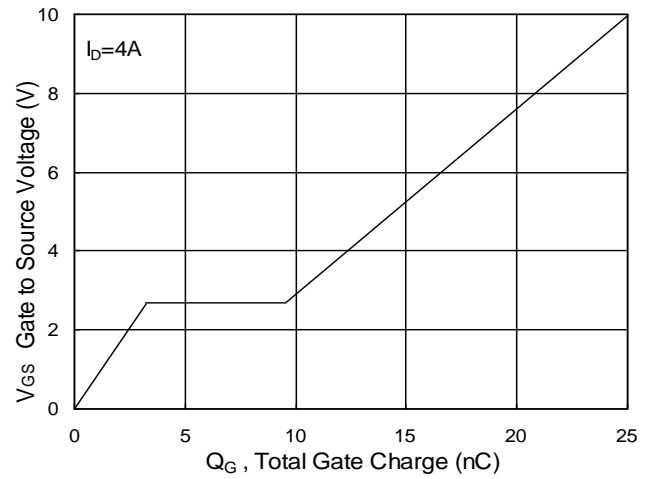


Fig.4 Gate-Charge Characteristics

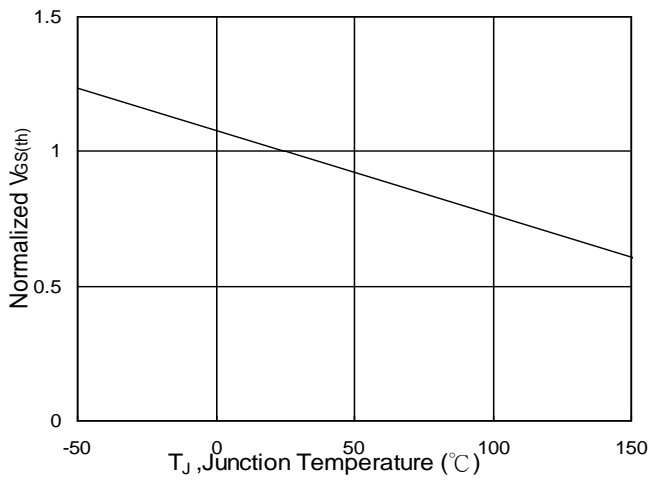


Fig.5 Normalized V_{GS(th)} v.s T_J

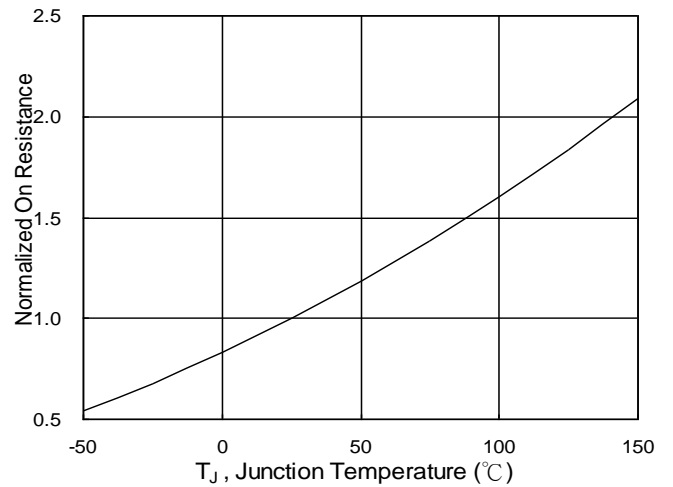


Fig.6 Normalized R_{DS(on)} v.s T_J

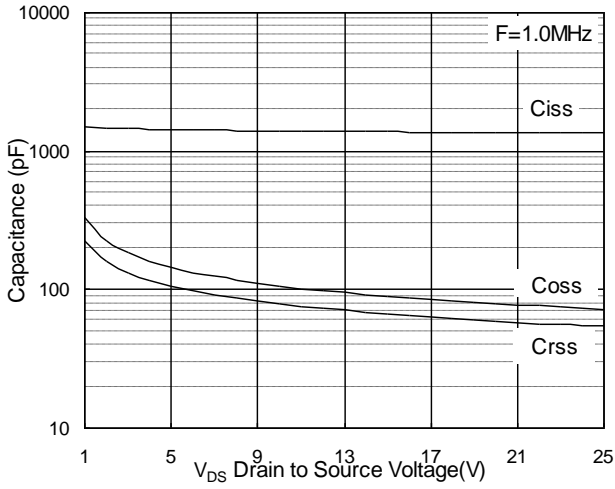


Fig.7 Capacitance

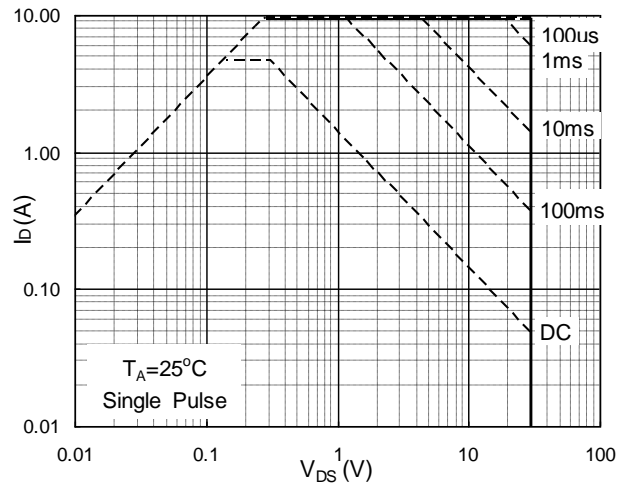


Fig.8 Safe Operating Area

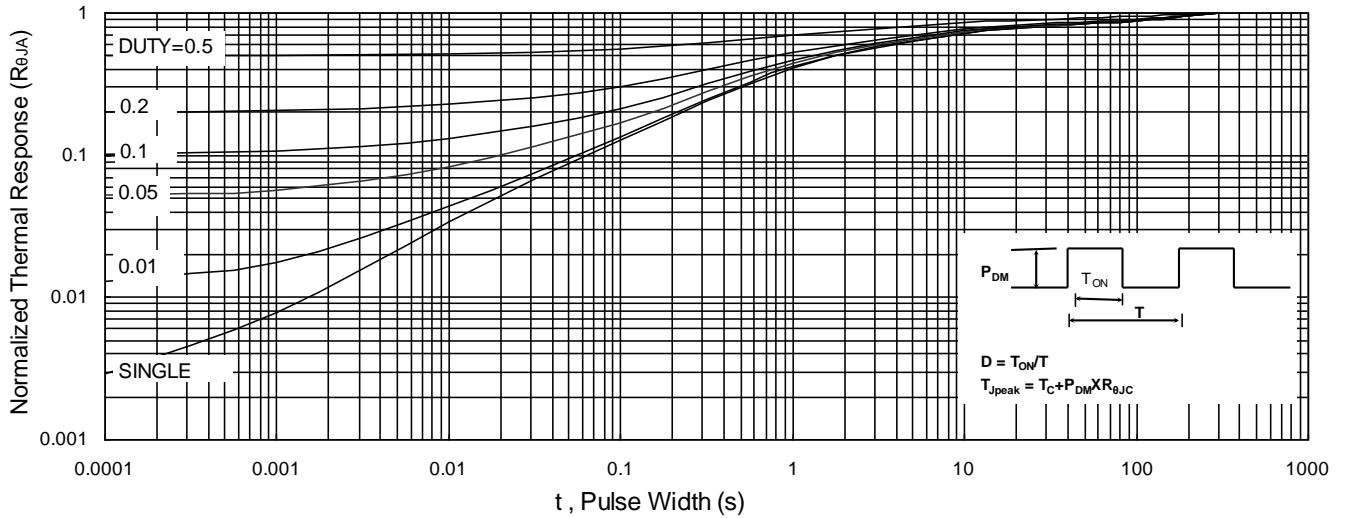


Fig.9 Normalized Maximum Transient Thermal Impedance

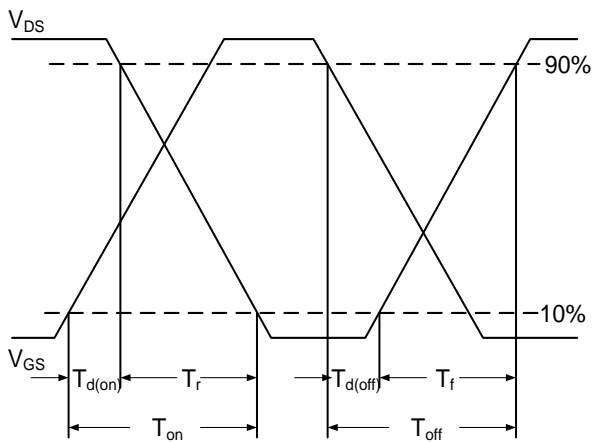


Fig.10 Switching Time Waveform

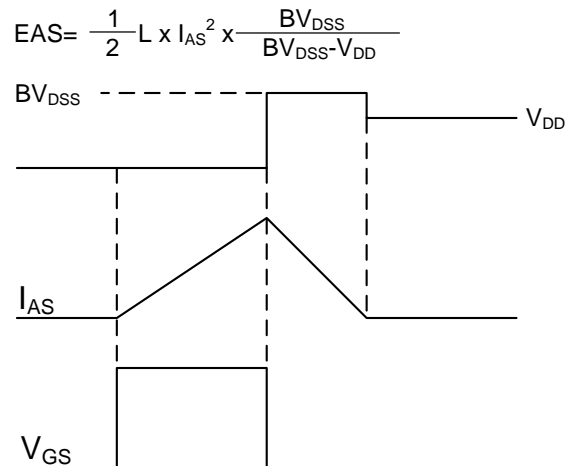


Fig.11 Unclamped Inductive Waveform

P-Channel Typical Characteristics

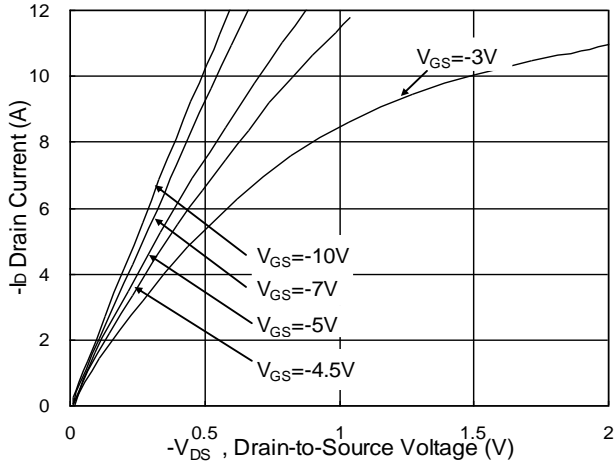


Fig.1 Typical Output Characteristics

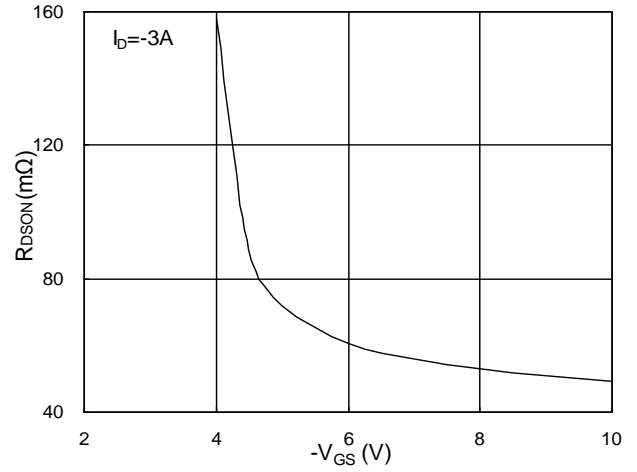


Fig.2 On-Resistance v.s Gate-Source

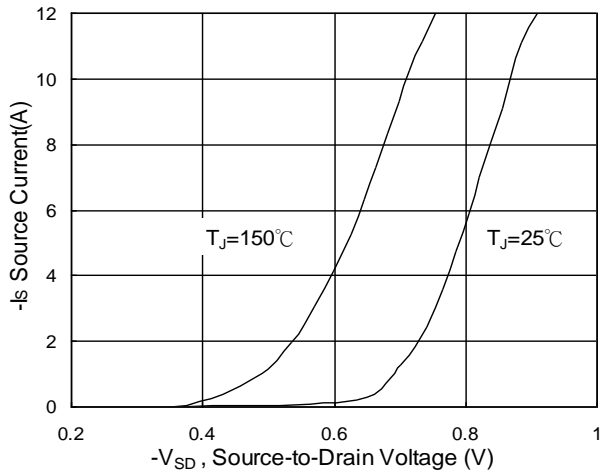


Fig.3 Forward Characteristics of Reverse

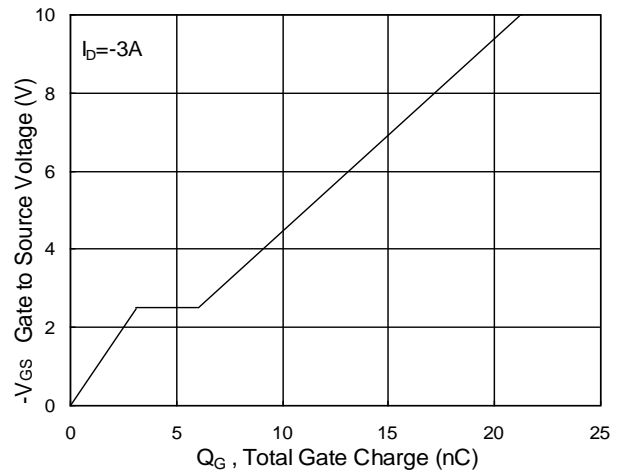


Fig.4 Gate-Charge Characteristics

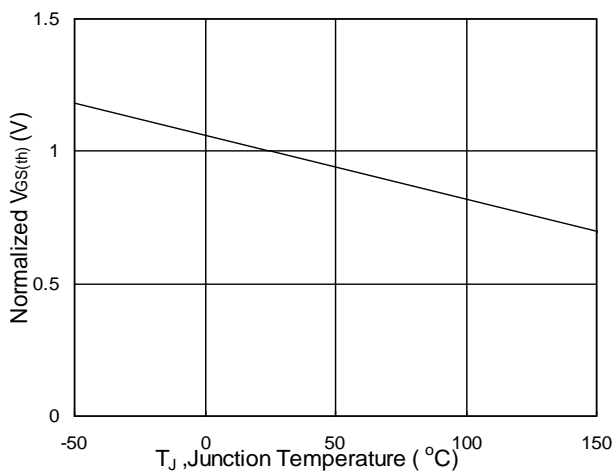


Fig.5 Normalized $V_{GS(th)}$ v.s T_J

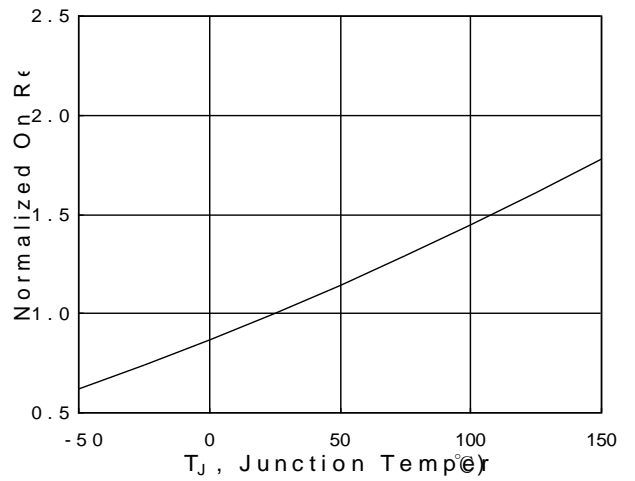
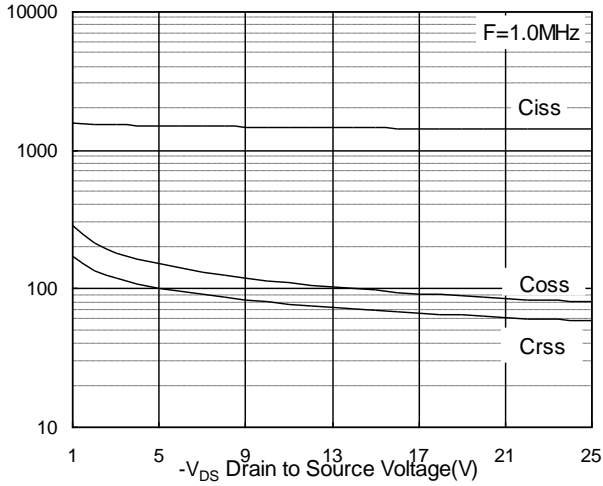
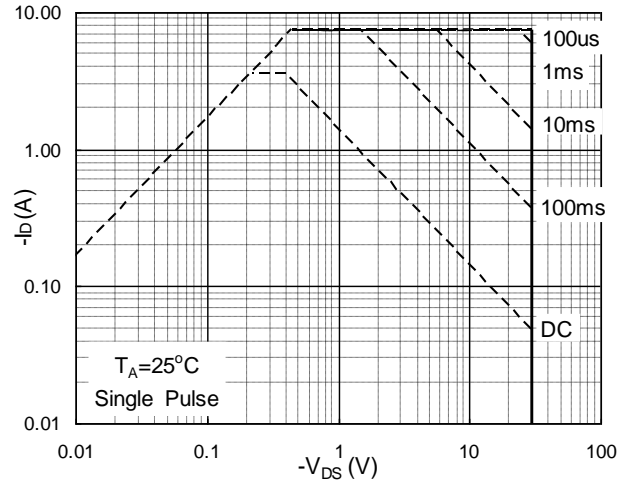
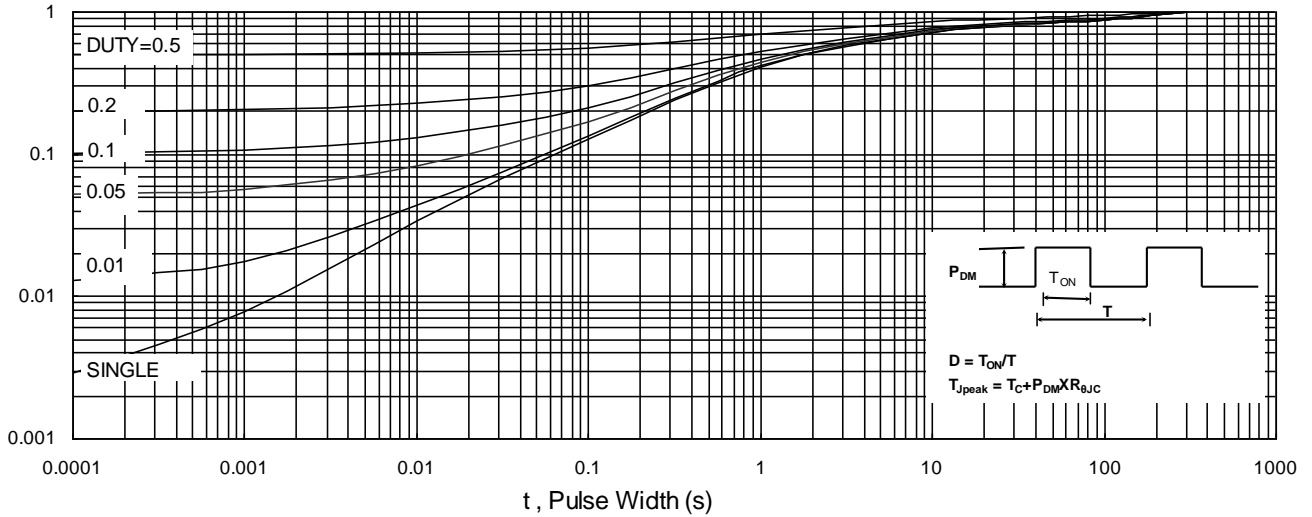
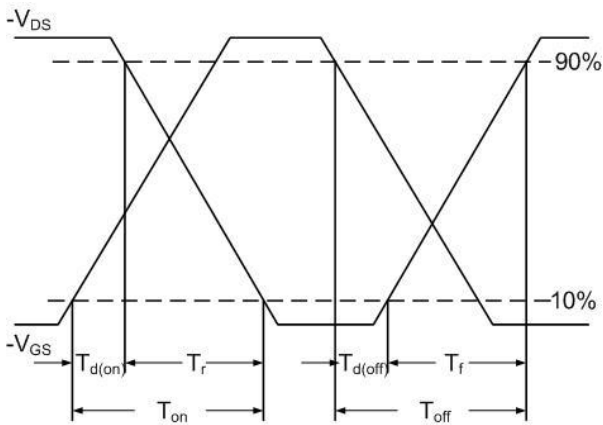
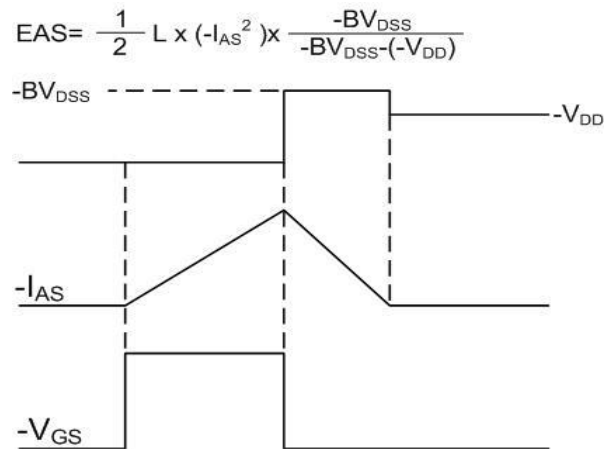


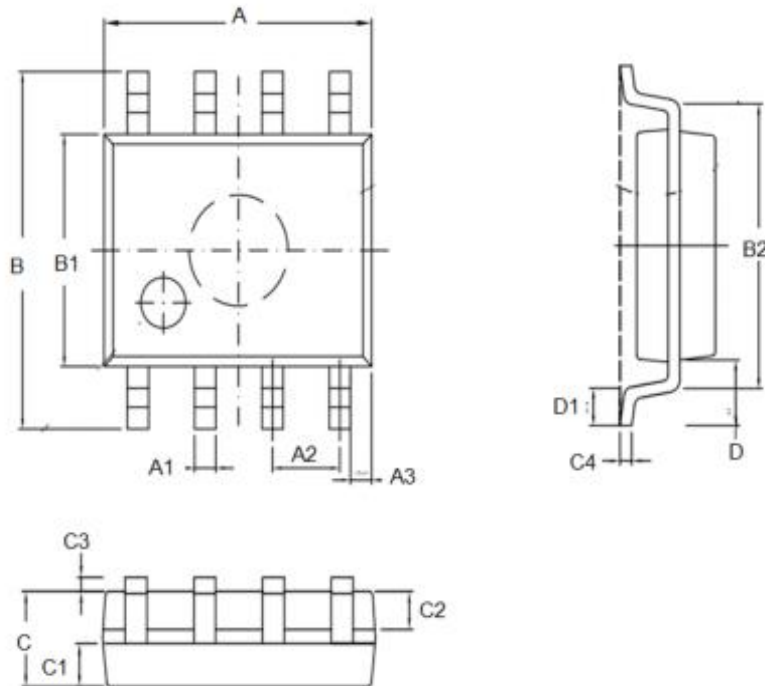
Fig.6 Normalized $R_{DS(on)}$ v.s T_J

P-Channel Typical Characteristics


Fig.7 Capacitance

Fig.8 Safe Operating Area

Fig.9 Normalized Maximum Transient Thermal Impedance

Fig.10 Switching Time Waveform

Fig.11 Unclamped Inductive Waveform

•Dimensions(SOP8)

SYMBOL	min	TYP	max	SYMBOL	min		max
A	4.80		5.00	C	1.30		1.50
A1	0.37		0.47	C1	0.55		0.75
A2		1.27		C2	0.55		0.65
A3		0.41		C3	0.05		0.20
B	5.80		6.20	C4	0.19	0.20	0.23
B1	3.80		4.00	D		1.05	
B2		5.00		D1	0.40		0.62




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